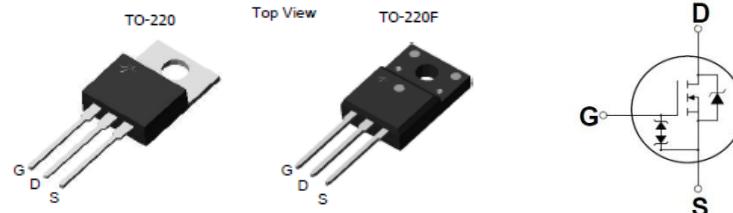


## Features

- Low gate charge
- 100% avalanche tested
- Improved dv/dt capability
- RoHS compliant
- Halogen free package
- JEDEC Qualification
- Improved ESD performance

N-channel MOSFET

$BV_{DSS}$	$I_D$	$R_{DS(on)}$
600V	4.0A	< 2.5Ω



Device	Package	Marking	Remark
TMP4N60AZ / TMPF4N60AZ	TO-220 / TO-220F	TMP4N60AZ / TMPF4N60AZ	RoHS
TMP4N60AZG / TMPF4N60AZG	TO-220 / TO-220F	TMP4N60AZG / TMPF4N60AZG	Halogen Free

## Absolute Maximum Ratings

Parameter	Symbol	TMP4N60AZ(G)	TMPF4N60AZ(G)	Unit
Drain-Source Voltage	$V_{DSS}$	600		V
Gate-Source Voltage	$V_{GS}$	±30		V
Continuous Drain Current  $T_C = 25\text{ °C}$	$I_D$	4	4 *	A
$T_C = 100\text{ °C}$		2.34	2.34 *	A
Pulsed Drain Current (Note 1)	$I_{DM}$	16	16 *	A
Single Pulse Avalanche Energy (Note 2)	$E_{AS}$	192		mJ
Repetitive Avalanche Current (Note 1)	$I_{AR}$	4		A
Repetitive Avalanche Energy (Note 1)	$E_{AR}$	8.62		mJ
Power Dissipation  $T_C = 25\text{ °C}$	$P_D$	86.2	30.4	W
Derate above 25 °C		0.68	0.24	W/°C
Peak Diode Recovery dv/dt (Note 3)	dv/dt	4.5		V/ns
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	-55~150		°C
Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	$T_L$	300		°C

\* Limited only by maximum junction temperature

## Thermal Characteristics

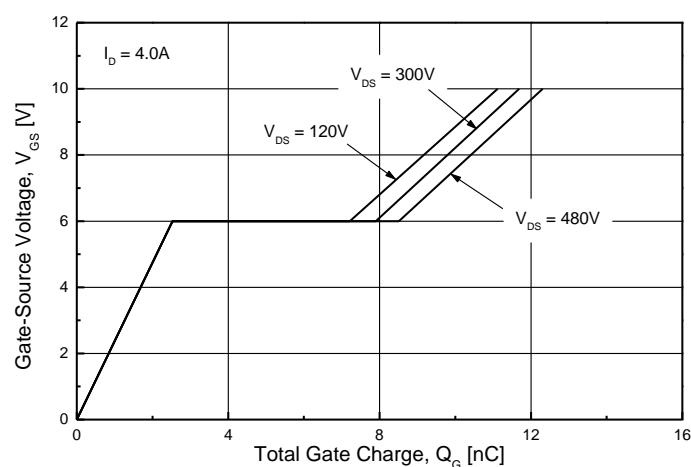
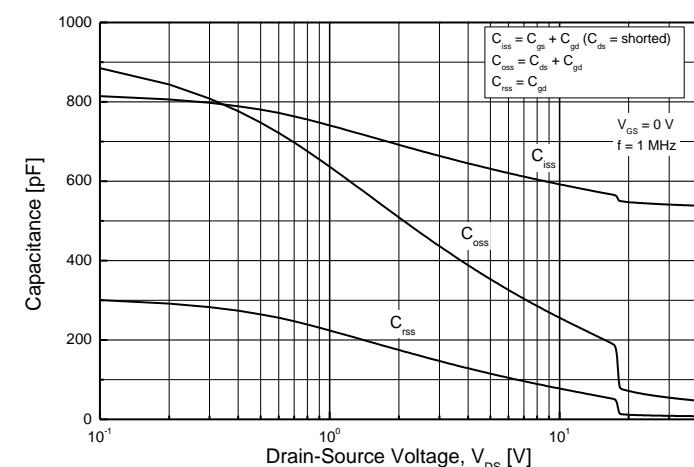
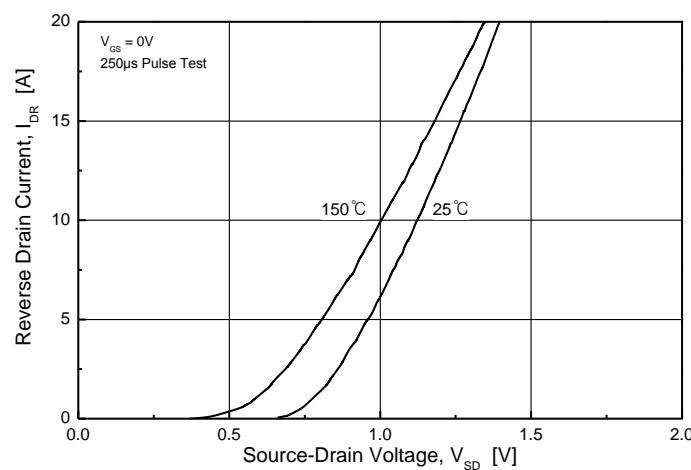
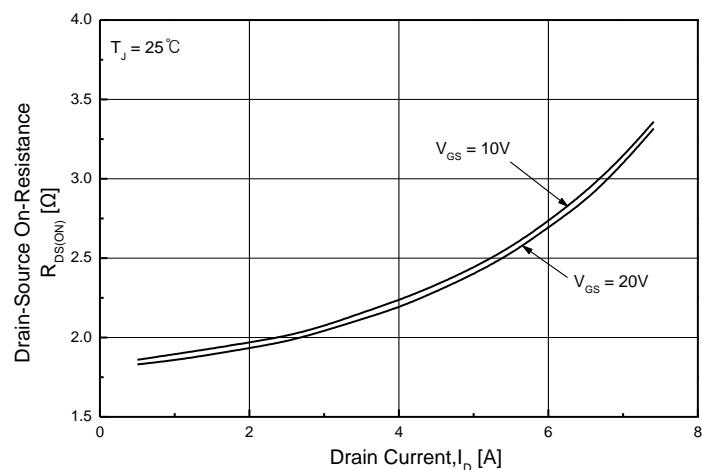
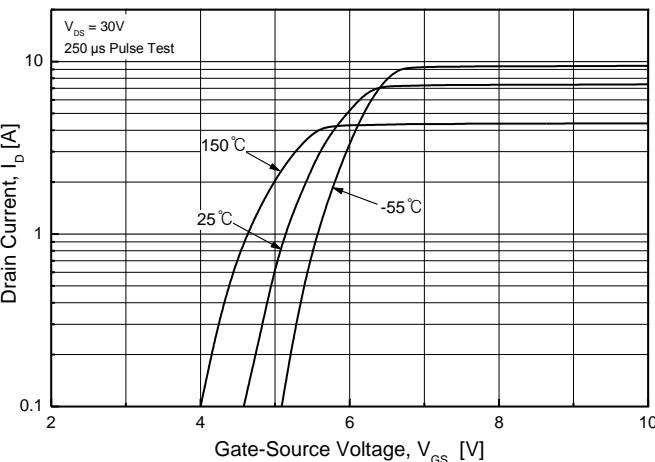
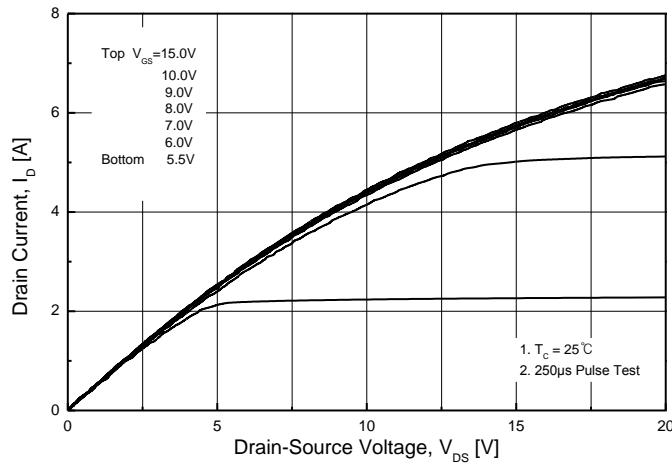
Parameter	Symbol	TMP4N60AZ(G)	TMPF4N60AZ(G)	Unit
Maximum Thermal resistance, Junction-to-Case	$R_{\theta JC}$	1.45	4.1	°C/W
Maximum Thermal resistance, Junction-to-Ambient	$R_{\theta JA}$	62.5	62.5	°C/W

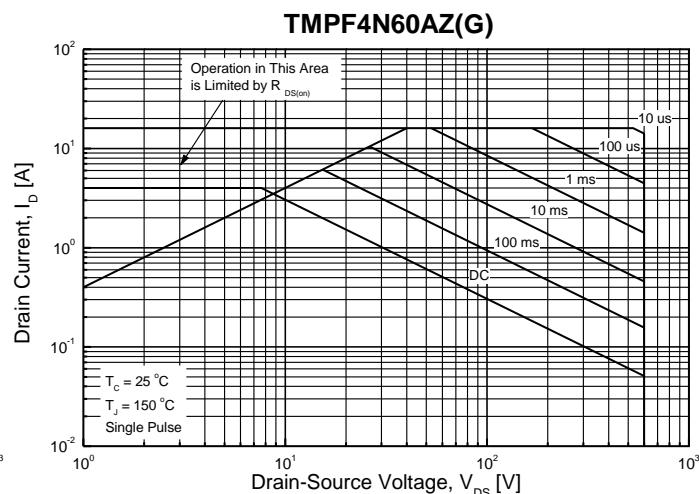
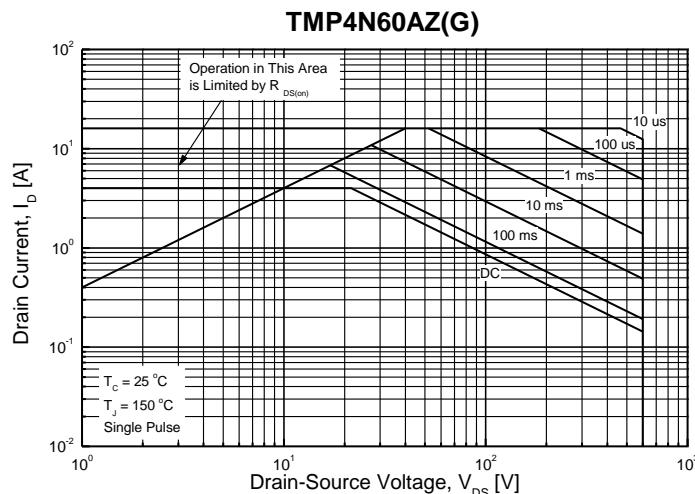
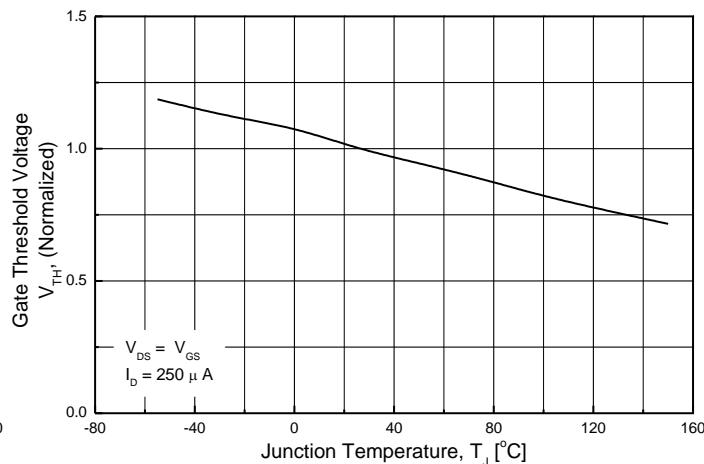
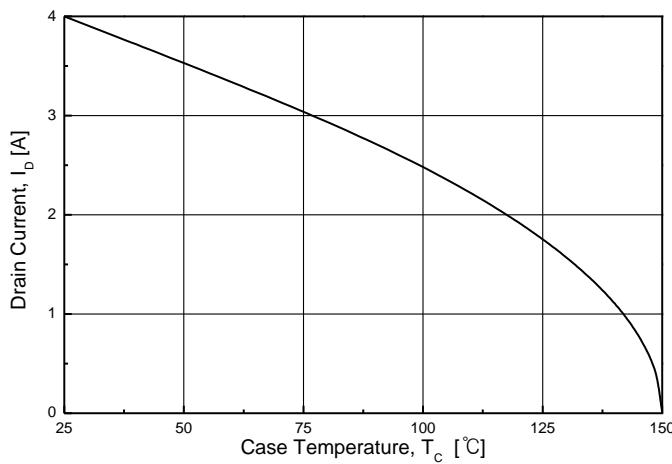
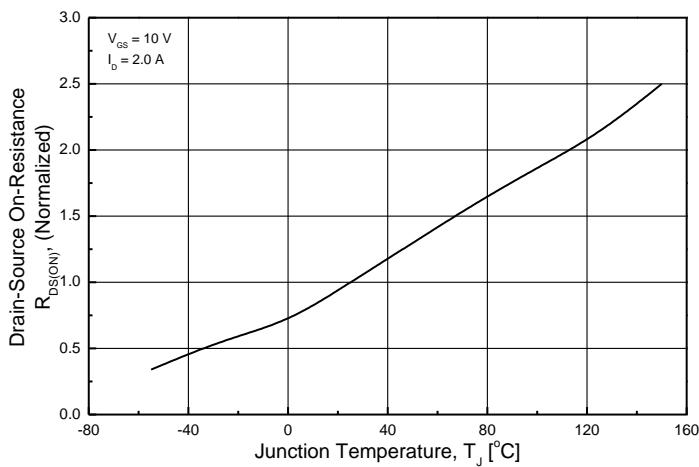
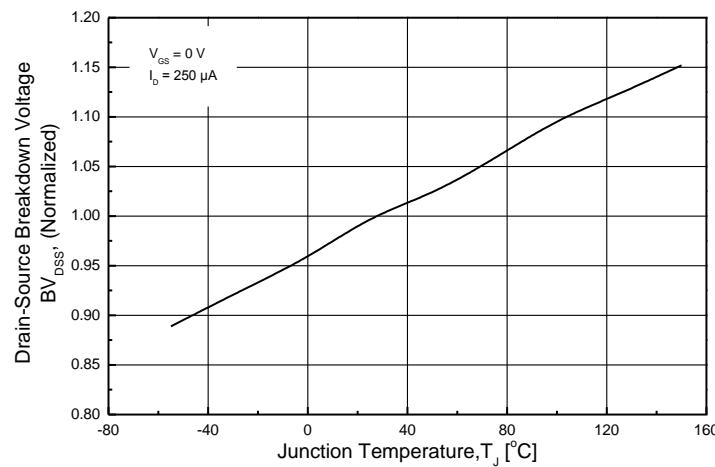
**Electrical Characteristics :  $T_c=25^\circ\text{C}$ , unless otherwise noted**

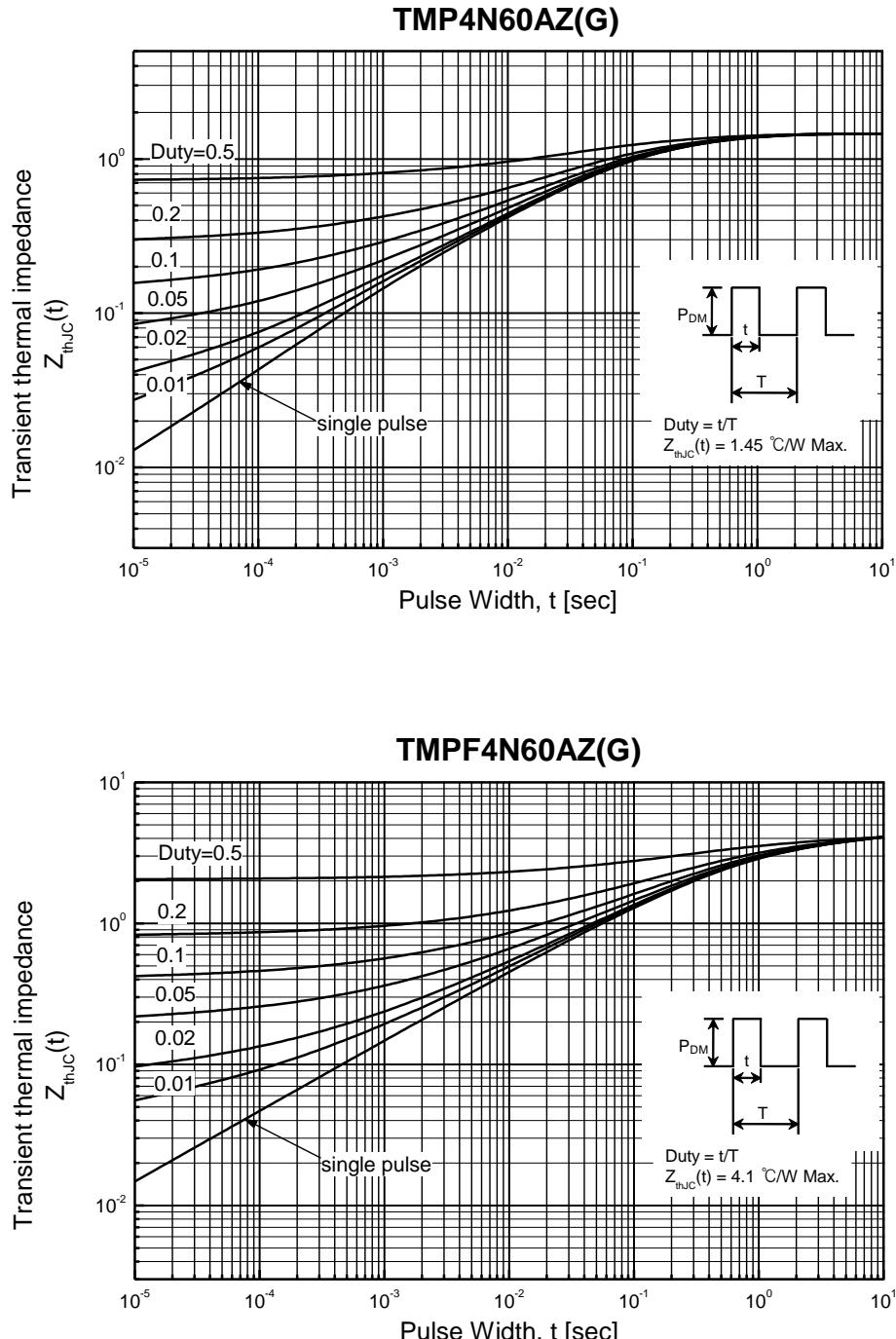
Parameter	Symbol	Test condition	Min	Typ	Max	Units
<b>OFF</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}} = 0 \text{ V}, I_{\text{D}} = 250 \mu\text{A}$	600	--	--	V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}} = 600 \text{ V}, V_{\text{GS}} = 0 \text{ V}$	--	--	1	$\mu\text{A}$
		$V_{\text{DS}} = 480 \text{ V}, T_c = 125^\circ\text{C}$	--	--	10	$\mu\text{A}$
Forward Gate-Source Leakage Current	$I_{\text{GSSF}}$	$V_{\text{GS}} = 30 \text{ V}, V_{\text{DS}} = 0 \text{ V}$	--	--	100	$\mu\text{A}$
Reverse Gate-Source Leakage Current	$I_{\text{GSSR}}$	$V_{\text{GS}} = -30 \text{ V}, V_{\text{DS}} = 0 \text{ V}$	--	--	-100	$\mu\text{A}$
<b>ON</b>						
Gate Threshold Voltage	$V_{\text{GS(th)}}$	$V_{\text{DS}} = V_{\text{GS}}, I_{\text{D}} = 250 \mu\text{A}$	3	--	5	V
Drain-Source On-Resistance	$R_{\text{DS(on)}}$	$V_{\text{GS}} = 10 \text{ V}, I_{\text{D}} = 2.0 \text{ A}$	--	2.0	2.5	$\Omega$
Forward Transconductance <sup>(Note 4)</sup>	$g_{\text{FS}}$	$V_{\text{DS}} = 30 \text{ V}, I_{\text{D}} = 2.0 \text{ A}$	--	6	--	S
<b>DYNAMIC</b>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DS}} = 25 \text{ V}, V_{\text{GS}} = 0 \text{ V}, f = 1.0 \text{ MHz}$	--	545	--	pF
Output Capacitance	$C_{\text{oss}}$		--	61	--	pF
Reverse Transfer Capacitance	$C_{\text{rss}}$		--	10	--	pF
<b>SWITCHING</b>						
Turn-On Delay Time <sup>(Note 4,5)</sup>	$t_{\text{d(on)}}$	$V_{\text{DD}} = 300 \text{ V}, I_{\text{D}} = 4.0 \text{ A}, R_{\text{G}} = 25 \Omega, V_{\text{GS}} = 10 \text{ V}$	--	18	--	ns
Turn-On Rise Time <sup>(Note 4,5)</sup>	$t_r$		--	27	--	ns
Turn-Off Delay Time <sup>(Note 4,5)</sup>	$t_{\text{d(off)}}$		--	47	--	ns
Turn-Off Fall Time <sup>(Note 4,5)</sup>	$t_f$		--	21	--	ns
Total Gate Charge <sup>(Note 4,5)</sup>	$Q_g$	$V_{\text{DS}} = 480 \text{ V}, I_{\text{D}} = 4.0 \text{ A}, V_{\text{GS}} = 10 \text{ V}$	--	12	--	nC
Gate-Source Charge <sup>(Note 4,5)</sup>	$Q_{\text{gs}}$		--	3	--	nC
Gate-Drain Charge <sup>(Note 4,5)</sup>	$Q_{\text{gd}}$		--	6	--	nC
<b>SOURCE DRAIN DIODE</b>						
Maximum Continuous Drain-Source Diode Forward Current	$I_s$	----	--	--	4	A
Maximum Pulsed Drain-Source Diode Forward Current	$I_{\text{SM}}$	----	--	--	16	A
Drain-Source Diode Forward Voltage	$V_{\text{SD}}$	$V_{\text{GS}} = 0 \text{ V}, I_s = 4.0 \text{ A}$	--	--	1.5	V
Reverse Recovery Time <sup>(Note 4)</sup>	$t_{\text{rr}}$	$V_{\text{GS}} = 0 \text{ V}, I_s = 4.0 \text{ A}$ $dI_F / dt = 100 \text{ A}/\mu\text{s}$	--	316	--	ns
Reverse Recovery Charge <sup>(Note 4)</sup>	$Q_{\text{rr}}$		--	1.2	--	$\mu\text{C}$

Note :

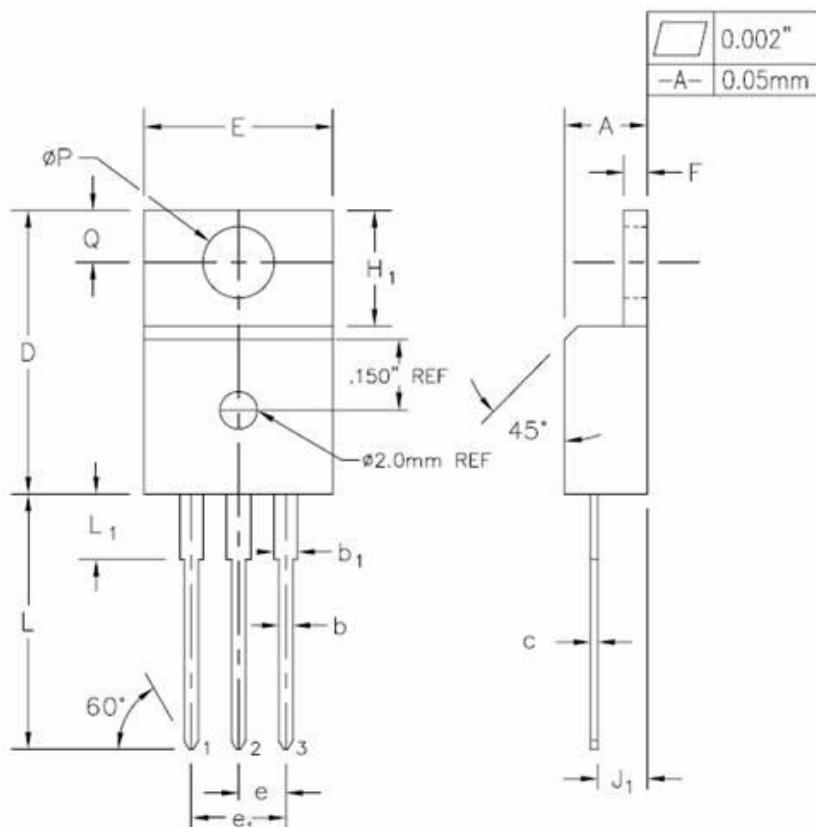
1. Repeated rating : Pulse width limited by safe operating area
2.  $L=22\text{mH}, I_{\text{AS}} = 4.0\text{A}, V_{\text{DD}} = 50\text{V}, R_{\text{G}} = 25\Omega$ , Starting  $T_J = 25^\circ\text{C}$
3.  $I_{\text{SD}} \leq 4.0\text{A}, dI/dt \leq 200\text{A}/\mu\text{s}, V_{\text{DD}} \leq \text{BV}_{\text{DS}}$ , Starting  $T_J = 25^\circ\text{C}$
4. Pulse Test : Pulse width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$
5. Essentially Independent of Operating Temperature Typical Characteristics





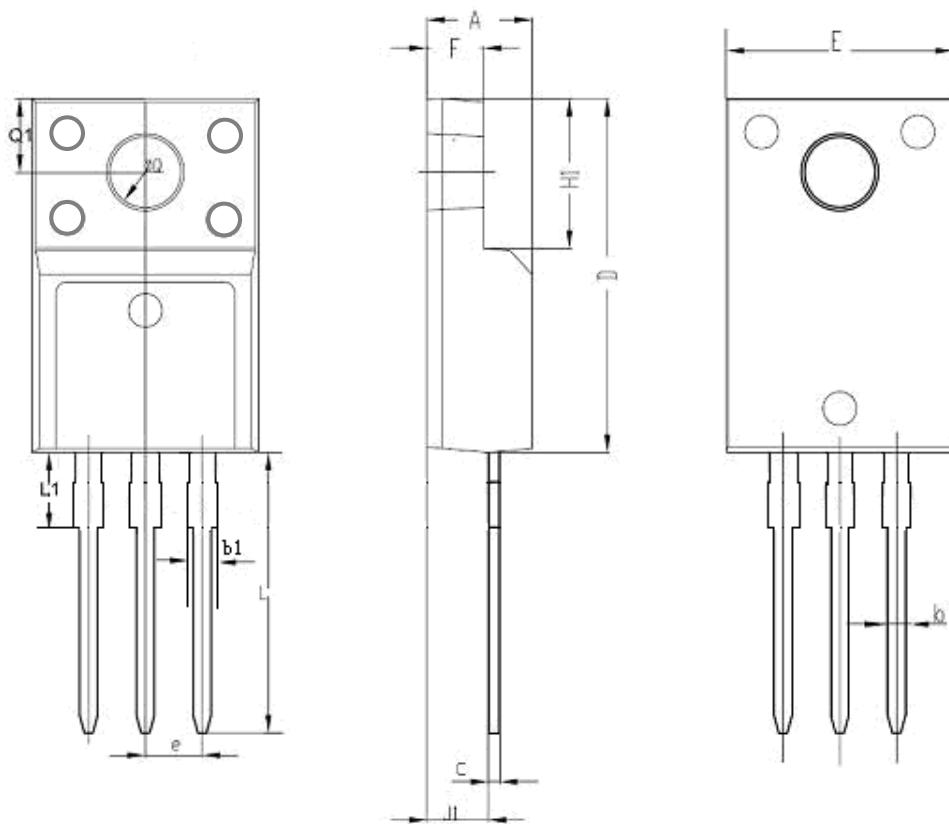


## TO-220AB-3L MECHANICAL DATA



SYMBOL	INCHES				NOTES
	MIN.	MAX.	MIN.	MAX.	
A	0.170	0.180	4.32	4.57	
b	0.028	0.036	0.71	0.91	
b <sub>1</sub>	0.045	0.055	1.15	1.39	
c	0.014	0.021	0.36	0.53	
D	0.590	0.610	14.99	15.49	
E	0.395	0.410	10.04	10.41	
e	0.100 TYP.		2.54 TYP.		
e <sub>1</sub>	0.200 BSC		5.08 BSC		
F	0.048	0.054	1.22	1.37	
H <sub>1</sub>	0.235	0.255	5.97	6.47	
J <sub>1</sub>	0.100	0.110	2.54	2.79	
L	0.530	0.550	13.47	13.97	
L <sub>1</sub>	0.130	0.150	3.31	3.81	2
øP	0.149	0.153	3.79	3.88	
Q	0.102	0.112	2.60	2.84	

## TO-220F-3L MECHANICAL DATA



SYMBOL	INCHES		MILLIMETERS		NOTES
	MIN	MAX	MIN	MAX	
A	0.178	0.194	4.53	4.93	
b	0.028	0.036	0.71	0.91	
C	0.018	0.024	0.45	0.60	
D	0.617	0.633	15.67	16.07	
E	0.392	0.408	9.96	10.36	
e	0.100 TYP.		2.54TYP.		
H1	0.256	0.272	6.50	6.90	
J1	0.101	0.117	2.56	2.96	
L	0.503	0.519	12.78	13.18	
φQ	0.117	0.133	2.98	3.38	
b1	0.045	0.055	1.15	1.39	
L1	0.114	0.130	2.9	3.3	
Q1	0.122	0.138	3.10	3.50	
F	0.092	0.108	2.34	2.74	